

U.S. Patent Application Serial No. 09/889,577  
Amendment dated October 17, 2003  
Attorney Docket No. 010610

**Amendments to the Specification**

Please substitute the paragraph bridging pages 4-5 of the specification as follows:

28 ~~As described in Claim 1, a~~ A cooler for an electronic device according to the present invention, which has been made to attain the object described above is a cooler for an electronic device which cools a heating element provided on the electronic device, which comprises: a liquid cooling mechanism composed of a heat sink which is formed in a flat shape, having a heat-receiving face at one surface thereof intended to be in contact with said electronic device, and having a liquid channel accommodated therein, a pump portion comprising a housing which is formed into a flat shape and which has an impeller, which can be rotated, provided therein, and metal pipes, each of which connects said liquid channel to said pump portion; and a forcible air cooling mechanism, composed of a radiating fin provided on the outer surface of said metal pipes, and a fan which cools said radiating fin and said housing, said liquid cooling mechanism and said forcible air cooling mechanism being unified with each other.